

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1069	single! with batch! with continuous	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/22 11:52
L2	0	interposer with 1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/22 11:53
L3	3	interposer and 1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/22 11:54
L4	1819542	semiconductor integrated adj circuit ic	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/22 11:54
L5	7	1 with 4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/22 12:58
L6	2	("5679977").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/04/22 12:59
L7	2	("5148265").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/04/22 13:02
L8	2	("5347159").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/04/22 13:05
L9	2	("5148266").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/04/22 13:05

S1	15144613	@ad>"19900923" @rlad>"19900923" @pt1d>"19900923"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:39
S2	64646	dice\$ scribe\$ dicing scribing	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:11
S3	20565	S2 not S1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:11
S4	4726	wafer and S3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:11
S5	1443679	wire\$	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:11
S6	860	S4 and S5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:12
S7	191869	encap\$	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:12
S8	693	S6 and "7"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:14
S10	5806	singulat\$	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:14
S11	1788	S10 with wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:14

S12	8	S11 not S1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:16
S13	18247	S2 with wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:16
S14	5901	S13 and S5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:16
S15	649	S14 not S1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:16
S16	116	S15 and S7	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:16
S17	30	("3478420" "3496631" "3584264" "3610870" "3706840" "3708870" "3762039" "3903590").PN. OR ("3978578").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/19 20:21
S18	15	S17 not S1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:24
S19	2856	S2 with S5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:24
S20	650	S19 with wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:24
S21	106	S20 not S1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:25

S22	86	S21 not S16	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:28
S23	3	"02155261"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:32
S24	1	1990-227550.NRAN.	DERWENT	OR	ON	2004/04/19 20:28
S25	1917604	cut cutting saw sawing sawed	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:32
S26	25087	S25 with wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:32
S27	1519	S5 with S26	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:33
S28	178	S27 not S1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:33
S29	149	S28 not (S21 or S16)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:33
S30	7	("2303346" "3711625" "3978578" "4482874" "4687693" "4761335").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/19 20:36
S31	3	("4906314").URPN.	USPAT	OR	ON	2004/04/19 20:36
S32	3	"02155261"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:40
S33	3	"04107846"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:45

S34	1	1992-171325.NRAN.	DERWENT	OR	ON	2004/04/19 20:40
S35	371	interposer with wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:45
S36	7	S35 not S1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:55
S37	3	"02144932"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:58
S38	1	1990-214060.NRAN.	DERWENT	OR	ON	2004/04/19 20:55
S39	1470	S7 with S2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:58
S40	1056	S39 and wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:58
S41	45	S40 not S1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 20:59
S42	2014	S7 with wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 21:00
S43	385	S42 not S1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 21:00
S44	122	S43 and S5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 21:00

S45	25	("3319068" "3370174" "3480783" "3636358" "3639770" "3699407" "3845318" "3914137" "3975751").PN. OR ("4040078").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/19 21:04
S46	19	S45 not S1	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/19 21:11
S47	1677	wafer with (die chip dice) with S5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 21:12
S48	284	S47 not S1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 21:12
S49	208	S48 not (S16 S21 S22)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 21:13
S50	97	("3312871" "3445823" "3558992" "3726002" "3777221" "3803483" "3981070" "4234888" "4295182" "4364044").PN. OR ("4467400").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/19 21:22
S51	37	S50 not S1	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/19 21:22
S52	9	("3365620" "3374533" "3457541" "3596140" "3619734" "3648131").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/19 21:26
S53	32	("3365620" "3374533" "3457541" "3596140" "3619734" "3648131").PN. OR ("3959579").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/19 21:27
S54	18	S53 not S1	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/19 21:29
S55	5028	wafer! adj scale wsi	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/19 21:36
S56	89	S5 with S55	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/19 21:30

S57	14	S56 not S1	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/19 21:31
S58	777	S55 not S1	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/19 21:31
S59	146	S58 and S5	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/19 21:31
S60	132	S59 not S57	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/19 21:32
S61	34	("3158927" "3258898" "3621565" "3846198" "3959045" "4059708" "4168998" "4255208" "4530152" "4635356" "4709468" "4711859" "4774194").PN. OR ("5032543"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/19 21:34
S62	17	S61 not S1	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/19 21:35
S63	6437	wafer! adj scale wsi	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 21:36
S64	1293	S63 not S1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 21:37
S65	226	S64 and S5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/19 21:37
S66	50	("4695870").URPN.	USPAT	OR	ON	2004/04/19 21:42
S67	50	("4695870").URPN.	USPAT	OR	ON	2004/04/19 21:42
S68	9	S67 not S1	USPAT	OR	ON	2004/04/19 21:49
S69	2	("5950070").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/04/19 21:49

S70	30	("4426773" "5126286" "5139972" "5148265" "5258330" "5282312" "5346861" "5347159" "5367764" "5390844" "5398863" "5414298" "5455390" "5477611" "5489749" "5491302" "5518964" "5525545" "5536909" "5548091" "5557501" "5558270" "5558928" "5570504" "5583321" "5590460" "5597470" "5615824" "5619017" "5731222").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/19 21:49
S71	1	S70 not S1	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/20 18:21
S73	298	khandros.in.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 20:31
S75	6	("9505582").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/04/20 18:53
S76	4	("9205582").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/04/20 19:03
S77	1	1992-132352.NRAN.	DERWENT	OR	ON	2004/04/20 19:00
S79	4070	@ad="19920402"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 19:40
S80	6210	@pd="19920402"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 19:40
S81	948	@pd="19920402"	EPO	OR	ON	2004/04/20 19:42
S82	3	wafer and S81	EPO	OR	ON	2004/04/20 19:44
S83	0	wafer and S81	DERWENT	OR	ON	2004/04/20 19:41
S84	948	@pd="19920402"	EPO	OR	ON	2004/04/20 19:42

S85	67	920558?	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 19:47
S86	2	("920558?").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/04/20 19:47
S87	1	1993-320988.NRAN.	DERWENT	OR	ON	2004/04/20 19:50
S88	14722448	@ad>"19900923" @rlad>"19900923" @pt1d>"19900923"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 20:29
S89	34	S73 not S88	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 20:30
S90	156	wafer and S73	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 20:33
S91	362	"5148266"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 20:33
S93	2	("5148266").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/04/20 20:34
S94	1	1992-132352.NRAN.	DERWENT	OR	ON	2004/04/20 20:36
S95	1	(WO-9205582-\$ or AU-9187312-\$ or US-5148265-\$ or US-5148266-\$ or EP-551382-\$ or US-5258330-\$ or JP-06504408-\$ or US-5346861-\$ or EP-551382-\$ or US-5682061-\$ or KR-9705709-\$ or CA-2091438-\$ or EP-1111672-\$ or EP-551382-\$ or DE-69132880-\$ or ES-2167313-\$ or US-6392306-\$ or US-6465893-\$ or EP-1353374-\$). did.	DERWENT	OR	ON	2004/04/20 20:37

S96	10	(WO-9205582-\$ or AU-9187312-\$ or US-5148265-\$ or US-5148266-\$ or EP-551382-\$ or US-5258330-\$ or JP-06504408-\$ or US-5346861-\$ or EP-551382-\$ or US-5682061-\$ or KR-9705709-\$ or CA-2091438-\$ or EP-1111672-\$ or EP-551382-\$ or DE-69132880-\$ or ES-2167313-\$ or US-6392306-\$ or US-6465893-\$ or EP-1353374-\$). did.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 20:37
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S97	613	("3302067" "3390308" "3426252" "3474297" "3487541" "3611061" "3614832" "3680037" "3680206" "3683105" "3689991" "3724068" "3772575" "3795037" "3823467" "3825353" "3832769" "3862790" "3864728" "3868724" "3925404" "3952404" "4074342" "4179802" "4189825" "4225900" "4237607" "4349862" "4356374" "4371912" "4410905" "4437141" "4460825" "4525921" "4536469" "4545610" "4574470" "4597617" "4604644" "4627151" "4628406" "4638348" "4648179" "4649415" "4655524" "4658332" "4667220" "4670770" "4672737" "4681654" "4685998" "4686998" "4695870" "4700473" "4709468" "4710798" "4721993" "4734825" "4751199" "4751482" "4754316" "4761681" "4764804" "4766670" "4772936" "4783695" "4783719" "4793814" "4796078" "4801992" "4811081" "4811082" "4814295" "4818728" "4841355" "4842662" "4847146" "4855867" "4855872" "4860088" "4862249" "4866841" "4874721" "4878098" "4884122" "4884237" "4887148" "4890157" "4893172" "4897534" "4918811" "4924353" "4926241" "4937203" "4937653" "4937707" "4941033" "4942140" "4949224" "4953005" "4953060" "4954878" "4955132" "4956694" "4961105" "4967261" "4975765" "4982265" "4989069" "4993954" "4996583" "4996587" "5001542" "5006673" "5016158" "5019673" "5023205" "5027191" "5028086" "5030325"	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/20 20:38
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S98	136	S97 not S88	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/21 12:36
S99	199946	elastom\$	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/20 20:39
S10 1	13	S98 and S99	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 20:42
S10 2	117	S98 not S101	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:04
S10 3	3	Z adj AXIS adj Interconnect adj Film	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:11
S10 4	139	Z adj AXIS with anisotropic with adhesive	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:11
S10 5	3	S99 with S104	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:13
S10 6	1668027	elast\$ rubber compliant	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:13
S10 7	3	S104 with S106	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:14
S10 8	515	Sheldahl	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:14
S10 9	54256	z adj axis	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:15

S11 0	8	S109 with S108	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:18
S11 1	135	z:adj link	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:18
S11 2	0	S111 with S106	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:18
S11 3	43	S111 not S88	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:24
S11 4	327	anisotropic with silicone	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:25
S11 5	85	S114 not S88	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:29
S11 6	4356	anisotrop\$ with adhesive	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:29
S11 7	275	S116 with S106	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:30
S11 8	37	S117 not S88	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:40
S11 9	5064	interposer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:40

S12 0	1002	S119 not S88	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:40
S12 1	365	S119 with wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:40
S12 2	7	S121 not S88	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:44
S12 3	1021031	chip die	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:44
S12 4	2231	S123 with S119	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:44
S12 5	104	S124 not S88	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/20 21:45
S12 6	5	("4791473" "4796078" "4833521" "4862245" "4916519").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/04/20 21:52
S12 7	9483	sheet\$ with wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/21 12:38
S12 8	14722448	@ad>"19900923" @rlad>"19900923" @pt1d>"19900923"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/21 12:39
S12 9	2627	S127 not S128	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/21 12:39

S13 0	64185	dice\$ scribe\$ dicing scribing	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/21 12:39
S13 1	1066	S130 with S127	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/21 12:39
S13 2	270	S131 not S128	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/21 12:42
S13 3	690	(single each individual\$) with (chip die dice) with (entir\$ whole) with wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/21 12:44
S13 4	100	S133 not S128	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/21 12:45
S13 5	6441	wafer! adj scale wsi	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/04/21 12:45
S13 6	2	("4171477").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/04/21 19:51
S13 7	2	("4921810").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/04/21 21:22
S13 8	2	("5156319").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/04/21 21:41
S14 0	2	("5950070").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/04/22 11:51